

# Miniature Dual-Axis OIS Optimized MEMS Gyroscope

## Description

The IDG-2030U (roll & pitch) dual-axis MEMS angular rate sensor is designed for optical image stabilization (OIS) applications in camera modules found in smart phones and other mobile devices.

The OIS gyro includes a narrow programmable full-scale range of  $\pm 46.5$ ,  $\pm 93$ ,  $\pm 187$ , and  $\pm 374$  degrees/sec, fast sampling of the gyro output at up to 32KHz, low phase delay including a fast 20MHz read-out through SPI interface, very low rate noise at  $5\text{mdps}/\sqrt{\text{Hz}}$  and extremely low power consumption at 2.7 mA. Factory-calibrated initial sensitivity reduces production-line calibration requirements.

The space saving 2.3 x 2.3 x 0.65mm LGA surface mount package is reflow solder compatible and RoHS compliant.

The IDG-2030U is pin and function compatible to IDG-2030.

## Target Applications

- Smart Phone Camera OIS Modules
- OIS for Digital Still Camera and Video Cameras
- Electronic Image Stabilization (Video Jitter)
- Virtual Reality Mobile Devices

## Key Features

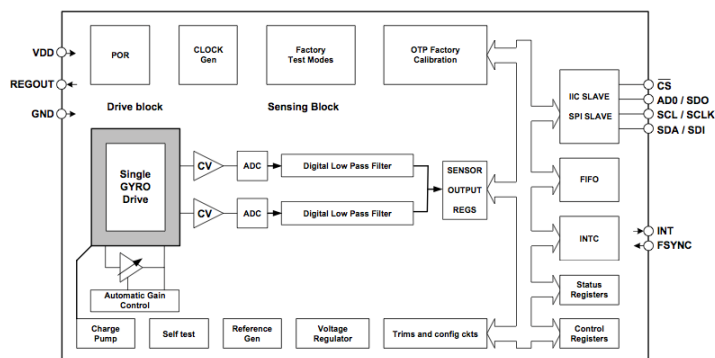
- Resistant to 36 kHz to 40 kHz ultrasonic wash frequencies
- Small 2.3 x 2.3 mm<sup>2</sup> & Low Profile 0.65 mm LGA Package
- Low  $5\text{mdps}/\sqrt{\text{Hz}}$  Noise
- Minimum Phase Delay of 0.9° at 20Hz
- Narrow FSR Range from  $\pm 46.5$  dps to  $\pm 374$  dps
- High Resolution at up to 700 LSB/(°/s)
- Embedded 512-byte FIFO Enables Burst Read
- SPI and I<sup>2</sup>C High-Speed Interfaces
- FSYNC Pin Supports Image Synchronization
- 400kHz Fast Mode I<sup>2</sup>C Serial Interface
- 1 MHz R/W SPI Interface, 20MHz Read to Gyro
- Wide 16-Bit Rate Value Data Output
- User-Programmable Integrated Low-Pass Filters
- Wide 1.71V to 3.6V Supply Voltage Range
- Low 5mW Power Consumption
- 6µA Sleep Mode
- High 10,000g Shock Survivability

## Ordering Information

| Part Number            | Axes | Temp Range     | Pin / Package |
|------------------------|------|----------------|---------------|
| IDG-2030U <sup>+</sup> | X,Y  | -40°C to +85°C | 12-Pin LGA    |

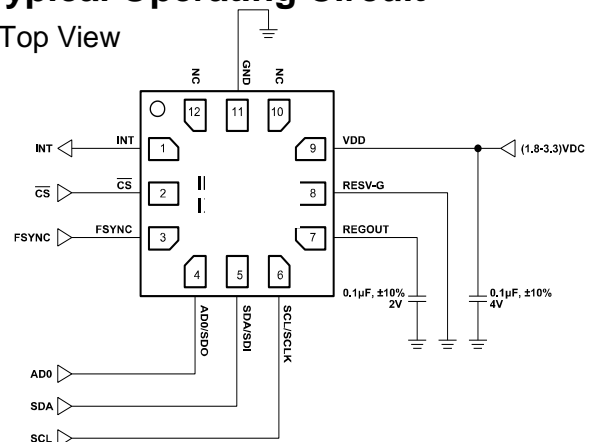
<sup>+</sup>Denotes RoHS- and green-compliant package.

## Block Diagram



## Typical Operating Circuit

Top View



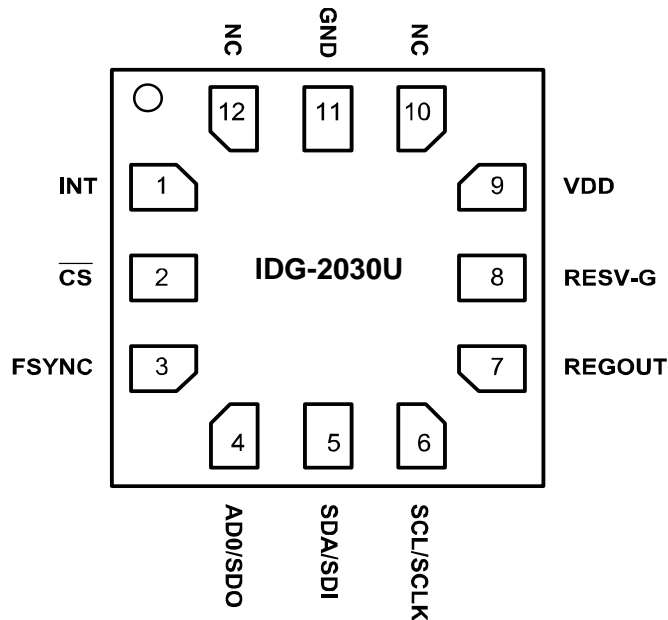
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## 1 Pin Description

| PIN | NAME                   | DESCRIPTION  |
|-----|------------------------|--|
| 1   | INT                    | Interrupt Digital Output (Totem pole or open-drain)                    |
| 2   | $\overline{\text{CS}}$ | SPI Chip Select (0=SPI mode, 1= I <sup>2</sup> C mode)                 |
| 3   | FSYNC                  | Frame Synchronization Digital Input. Connect to GND if not used.       |
| 4   | AD0 / SDO              | I <sup>2</sup> C Slave Address LSB (AD0); SPI Serial Data Output (SDO) |
| 5   | SDA/SDI                | I <sup>2</sup> C Serial Data (SDA); SPI Serial Data Input (SDI)        |
| 6   | SCL/SCLK               | I <sup>2</sup> C Serial Clock (SCL); SPI Serial Clock (SCLK)           |
| 7   | REGOUT                 | Regulator Output. Internal use only, bypass to GND with a 0.1µF cap.   |
| 8   | RESV-G                 | Reserved. Connect to GND.  |
| 9   | VDD                    | Analog and Digital I/O Power Supply. Bypass to GND with a 0.1µF cap.   |
| 10  | NC                     | Not Internally Connected. May be used for PCB trace routing.           |
| 11  | GND                    | Power Supply Ground  |
| 12  | NC                     | Not Internally Connected. May be used for PCB trace routing.           |

## Pin Configuration



Package: LGA 2.3 x 2.3 x 0.65 mm, Top View

## 2 Absolute Maximum Ratings

| Parameter                                | Rating                            |
|--|-----------------------------------|
| Supply Voltage, VDD                      | -0.5V to 4.0V                     |
| REGOUT                                   | -0.5V to 2V                       |
| Input Voltage Level (AD0, FSYNC)         | -0.5V to VDD                      |
| SCL, SDA, INT (SPI enable)               | -0.5V to VDD                      |
| SCL, SDA, INT (SPI disable)              | -0.5V to VDD                      |
| Acceleration (Any Axis, unpowered)       | 10,000g for 0.2ms                 |
| Storage Temperature Range                | -40°C to +125°C                   |
| Electrostatic Discharge (ESD) Protection | 2kV (HBM); 250V (MM)              |
| Latch-up                                 | JEDEC Class II (2), 125°C, ±100mA |

*Stress above those listed as “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to the absolute maximum ratings conditions for extended periods may affect device reliability.*

### 3 Electrical Characteristics

Typical Operating Circuit, VDD = 2.5V and TA=25°C unless otherwise noted.

| Parameter  | Conditions   | Min     | Typical                      | Max     | Unit   | Notes |
|--|--|---------|------------------------------|---------|--|-------|
| <b>Sensor Specifications</b>   |  |         |                              |         |  |       |
| <b>GYRO SENSITIVITY</b><br>Full-Scale Range  | FS_SEL=0 (default)<br>FS_SEL=1<br>FS_SEL=2<br>FS_SEL=3                             |         | ±46.5<br>±93<br>±187<br>±374 |         | °/s<br>°/s<br>°/s<br>°/s                         | 1     |
| Sensitivity Scale Factor   | FS_SEL=0<br>FS_SEL=1<br>FS_SEL=2<br>FS_SEL=3                                       |         | 700<br>350<br>175<br>87.5    |         | LSB/(°/s)<br>LSB/(°/s)<br>LSB/(°/s)<br>LSB/(°/s) |       |
| Gyro ADC Word Length   |  |         | 16                           |         | bits   |       |
| Sensitivity Scale Factor Tolerance   | 25°C   |         | ±3                           |         | %  | 1     |
| Sensitivity Scale Factor Variation Over Temperature                                    | -20°C to +75°C   |         | ±2                           |         | %  | 2     |
| Nonlinearity   | Best fit straight line; 25°C   |         | ±0.1                         |         | %  | 2     |
| Cross-Axis Sensitivity   |  |         | ±2                           |         | %  | 1     |
| <b>GYRO ZERO-RATE OUTPUT (ZRO)</b>   |  |         |                              |         |  |       |
| Initial ZRO Tolerance  | 25°C   |         | ±15                          |         | °/s  | 1     |
| ZRO Variation Over Temperature   | -20°C to +75°C   |         | ±8                           |         | °/s  | 2     |
| <b>SELF TEST RESPONSE</b>  |  |         |                              |         |  |       |
|  |  |         | 60                           |         | °/s  | 4     |
| <b>GYRO NOISE PERFORMANCE</b>  |  |         |                              |         |  |       |
| <b>Total RMS Noise</b>   | DLPFCFG=2 (92 Hz)<br>DLPFCFG=1 (184 Hz)<br>DLPFCFG=0 (256 Hz)                      |         | 0.06<br>0.085<br>0.10        |         | °/s-rms<br>°/s-rms<br>°/s-rms                    | 1     |
| Total Peak-to-Peak Noise   | DLPFCFG=2 (92 Hz)<br>DLPFCFG=1 (184 Hz)<br>DLPFCFG=0 (256 Hz)                      |         | 0.30<br>0.43<br>0.50         |         | °/s-p-p<br>°/s-p-p<br>°/s-p-p                    | 3     |
| Low-frequency RMS noise  | Bandwidth 1Hz to 10Hz  |         | 0.0055                       |         | °/s-rms  |       |
| Rate Noise Spectral Density  | Bandwidth 0.1 to 1Hz<br>At 10Hz  |         | 0.0055<br>0.005              |         | °/s-rms<br>°/s/√Hz                               | 1     |
| <b>GYRO MECHANICAL</b>   |  |         |                              |         |  |       |
| Mechanical Frequency   |  |         | 27                           |         | kHz  | 1     |
| Sensor Mechanical Bandwidth  |  |         |                              |         | kHz  | 2     |
| <b>Ultrasonic Wash Frequency</b>   |  | 36      |                              | 40      | kHz  | 2,5   |
| <b>VDD POWER SUPPLY</b>  |  |         |                              |         |  |       |
| Operating Voltage Range  |  | 1.71    |                              | 3.6     | V  | 2     |
| Power-Supply Ramp Rate   | Monotonic ramp. Ramp rate is 10% to 90% of the final value                         | 1       |                              | 100     | ms   | 2     |
| Normal Operating Current   | Two Axes Active  |         | 2.5                          |         | mA   | 1     |
| Sleep Mode Current   |  |         | 6                            |         | µA   | 1     |
| <b>GYRO START-UP TIME</b>  |  |         |                              |         |  |       |
| ZRO Settling   | DLPFCFG=0, to ±1°/s of Final<br>From Sleep Mode to ready<br>From Power On to ready |         | 35<br>50                     |         | ms<br>ms   |       |
| <b>OPERATING TEMPERATURE RANGE</b>   |  |         |                              |         |  |       |
|  |  |         |                              |         | °C   | 2     |
| <b>I<sup>2</sup>C ADDRESS</b>  |  |         |                              |         |  |       |
|  | AD0 = 0<br>AD0 = 1   |         | 1101000<br>1101001           |         |  |       |
| <b>DIGITAL INPUTS (FSYNC, AD0, SCLK, SDI, CS)</b>                                      |  |         |                              |         |  |       |
| VIH, High Level Input Voltage<br>VIL, Low Level Input Voltage<br>CI, Input Capacitance |  | 0.7*VDD |                              | 0.3*VDD | V<br>V<br>pF                                     | 2     |
| DIGITAL OUTPUT (INT, SDO)<br>VOH, High Level Output Voltage                            | RLOAD=1MΩ  | 0.9*VDD |                              |         | V  | 2     |

| Parameter  | Conditions   | Min | Typical                     | Max     | Unit | Notes |
|--|--|-----|-----------------------------|---------|------|-------|
| V <sub>OL1</sub> , LOW-Level Output Voltage                                      | R <sub>LOAD</sub> =1MΩ                             |     |                             | 0.1*VDD | V    |       |
| V <sub>OL,INT1</sub> , INT Low-Level Output Voltage                              | OPEN=1, 0.3mA sink current                         |     |                             | 0.1     | V    |       |
| Output Leakage Current   | OPEN=1   |     | 100                         |         | nA   |       |
| t <sub>INT</sub> , INT Pulse Width   | LATCH_INT_EN=0                                     |     | 50                          |         | μs   |       |
| <b>I<sup>2</sup>C I/O (SCL, SDA)</b>   |  |     |                             |         |      | 2     |
| V <sub>IL</sub> , LOW Level Input Voltage  |  |     | -0.5V to 0.3*VDD            |         | V    |       |
| V <sub>IH</sub> , HIGH-Level Input Voltage                                       |  |     | 0.7*VDD to VDD + 0.5V       |         | V    |       |
| V <sub>hys</sub> , Hysteresis  |  |     | 0.1*VDD                     |         | V    |       |
| V <sub>OL1</sub> , LOW-Level Output Voltage                                      | 3mA sink current                                   |     | 0 to 0.4                    |         | V    |       |
| I <sub>OL</sub> , LOW-Level Output Current                                       | V <sub>OL</sub> = 0.4V                             |     | 3                           |         | mA   |       |
|  | V <sub>OL</sub> = 0.6V                             |     | 6                           |         |      |       |
| Output Leakage Current   |  |     | 100                         |         | nA   |       |
| t <sub>of</sub> , Output Fall Time from V <sub>IHmax</sub> to V <sub>ILmax</sub> | C <sub>b</sub> bus capacitance in pf               |     | 20+0.1C <sub>b</sub> to 250 |         | ns   |       |
| C <sub>i</sub> , Capacitance for Each I/O pin                                    |  |     | < 10                        |         | pF   |       |
| <b>INTERNAL CLOCK SOURCE</b>   |  |     |                             |         |      | 2     |
| Sample Rate  | Fchoice=0,1,2<br>SMPLRT_DIV=0                      |     | 32                          |         | kHz  |       |
|  | Fchoice=3;<br>DLPFCFG=0 or 7<br>SMPLRT_DIV=0       |     | 8                           |         | kHz  |       |
|  | Fchoice=3;<br>DLPFCFG=1,2,3,4,5,6;<br>SMPLRT_DIV=0 |     | 1                           |         | kHz  |       |
| Clock Frequency Initial Tolerance  | CLK_SEL=0, 6; 25°C                                 | -5  |                             | +5      | %    |       |
|  | CLK_SEL=1,2,3,4,5; 25°C                            | -1  |                             | +1      | %    |       |
| Frequency Variation over Temperature   | CLK_SEL=0,6  |     | -10 to +10                  |         | %    |       |
|  | CLK_SEL=1,2,3,4,5                                  |     | ±1                          |         | %    |       |
| PLL Settling Time  | CLK_SEL=1,2,3,4,5                                  |     | 4                           |         | ms   |       |

Note 1: Tested in production

Note 2: Derived from validation of characterization of parts, not guaranteed in production

Note 3: Peak-Peak noise data is based on measurement of RMS noise in production and at 99% normal distribution

Note 4: Assumes environmental noise less than 2dps

Note 5: Please refer to Ultrasonic Wash Application Note.

## 4 Timing Characteristics

### 4.1 I<sup>2</sup>C Timing Diagrams

| Parameter   | Conditions                               | Min                  | Typical | Max | Unit | Notes |
|---|--|----------------------|---------|-----|------|-------|
| <b>I<sup>2</sup>C Timing Characteristics (I<sup>2</sup>C FAST-MODE)</b> |  |                      |         |     |      |       |
| f <sub>SCL</sub> , SCL Clock Frequency                                  |  | 0                    |         | 400 | kHz  | 1     |
| t <sub>HD,STA</sub> , START Condition Hold Time, repeated               |  | 0.6                  |         |     | μs   |       |
| t <sub>LOW</sub> , SCL Low Period                                       |  | 1.3                  |         |     | μs   |       |
| t <sub>HIGH</sub> , SCL High Period                                     |  | 0.6                  |         |     | μs   |       |
| t <sub>SU,STA</sub> , START Condition Setup Time, repeated              |  | 0.6                  |         |     | μs   |       |
| t <sub>HD,DAT</sub> , SDA Data Hold Time                                |  | 0                    |         |     | μs   |       |
| t <sub>SU,DAT</sub> , SDA Data Setup Time                               |  | 100                  |         |     | ns   |       |
| t <sub>r</sub> , SDA and SCL Rise Time                                  | C <sub>b</sub> bus cap. from 10 to 400pF | 20+0.1C <sub>b</sub> |         | 300 | ns   |       |
| t <sub>f</sub> , SDA and SCL Fall Time                                  | C <sub>b</sub> bus cap. from 10 to 400pF | 20+0.1C <sub>b</sub> |         | 300 | ns   |       |
| t <sub>SU,STO</sub> , STOP Condition Setup Time                         |  | 0.6                  |         |     | μs   |       |
| t <sub>BUF</sub> , Bus Free Time Between STOP and START Condition       |  | 1.3                  |         |     | μs   |       |
| C <sub>b</sub> , Capacitive Load for each Bus Line                      |  |                      | < 400   |     | pF   |       |
| t <sub>VD,DAT</sub> , Data Valid Time                                   |  |                      |         | 0.9 | μs   |       |
| t <sub>VD,ACK</sub> , Data Valid Acknowledge Time                       |  |                      |         | 0.9 | μs   |       |

Note 1: Derived from validation or characterization of parts, not guaranteed in production.

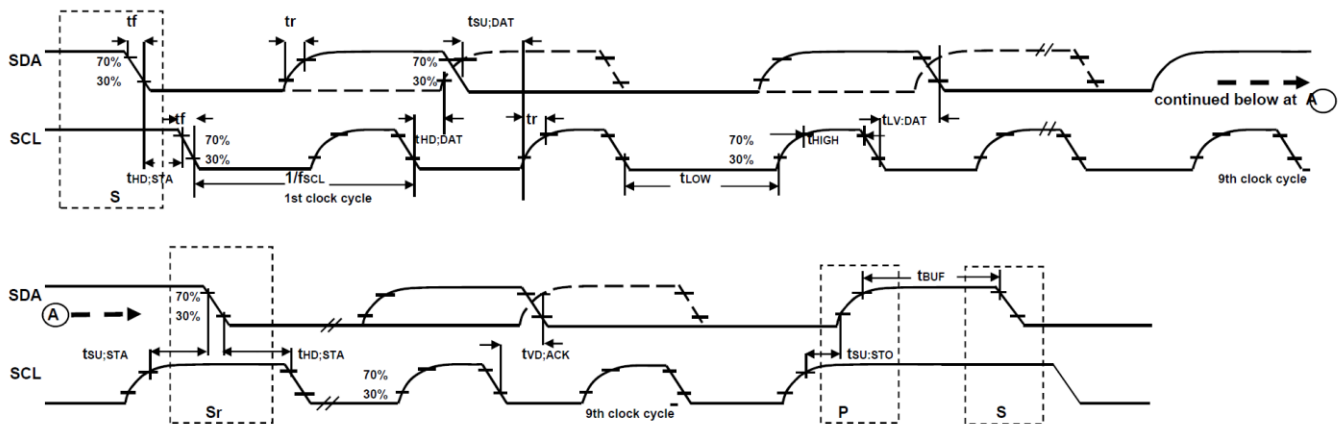


Figure 1: I<sup>2</sup>C Timing Diagram

**4.2 SPI Timing Diagrams**

| Parameter  | Conditions               | Min | Typical | Max | Unit | Notes |
|--|--------------------------|-----|---------|-----|------|-------|
| <b>SPI TIMING (f<sub>SCLK</sub> = 1 MHz) R/W</b>     |                          |     |         |     |      |       |
| f <sub>SCLK</sub> , SCLK Clock Frequency             |                          |     |         | 1   | MHz  | 1     |
| t <sub>LOW</sub> , SCLK Low Period                   |                          | 400 |         |     | ns   |       |
| t <sub>HIGH</sub> , SCLK High Period                 |                          | 400 |         |     | ns   |       |
| t <sub>SU,CS</sub> , CS Setup Time                   |                          | 8   |         |     | ns   |       |
| t <sub>HD,CS</sub> , CS Hold Time                    |                          | 500 |         |     | ns   |       |
| t <sub>SU,SDI</sub> , SDI Setup Time                 |                          | 11  |         |     | ns   |       |
| t <sub>HD,SDI</sub> , SDI Hold Time                  |                          | 7   |         |     | ns   |       |
| t <sub>VD,SDO</sub> , SDO Valid Time                 | C <sub>load</sub> = 20pF |     |         | 100 | ns   |       |
| t <sub>HD,SDO</sub> , SDO Hold Time                  |                          | 4   |         |     |      |       |
| t <sub>DIS,SDO</sub> , SDO Output Disable Time       |                          |     |         | 50  | ns   |       |
| t <sub>BUF</sub> , CS high time between transactions |                          |     |         | 600 | ns   |       |
| <b>SPI TIMING (f<sub>SCLK</sub> = 20 MHz) Read</b>   |                          |     |         |     |      |       |
| f <sub>SCLK</sub> , SCLK Clock Frequency             |                          |     |         | 20  | MHz  | 1, 2  |
| t <sub>LOW</sub> , SCLK Low Period                   |                          | -   | 25      | -   | ns   |       |
| t <sub>HIGH</sub> , SCLK High Period                 |                          | -   | 25      | -   | ns   |       |
| t <sub>SU,CS</sub> , CS Setup Time                   |                          | 25  |         |     | ns   |       |
| t <sub>HD,CS</sub> , CS Hold Time                    |                          | 25  |         |     | ns   |       |
| t <sub>SU,SDI</sub> , SDI Setup Time                 |                          | 5   |         |     | ns   |       |
| t <sub>HD,SDI</sub> , SDI Hold Time                  |                          | 6   |         |     | ns   |       |
| t <sub>VD,SDO</sub> , SDO Valid Time                 | C <sub>load</sub> = 20pF |     |         | 30  | ns   |       |
| t <sub>HD,SDO</sub> , SDO Hold Time                  |                          | 4   |         |     |      |       |
| t <sub>DIS,SDO</sub> , SDO Output Disable Time       |                          |     |         | 25  | ns   |       |
| t <sub>BUF</sub> , CS high time between transactions |                          |     |         | 600 | ns   |       |

Note 1: Derived from validation of characterization of parts, not guaranteed in production

Note 2: Read of Sensor registers only

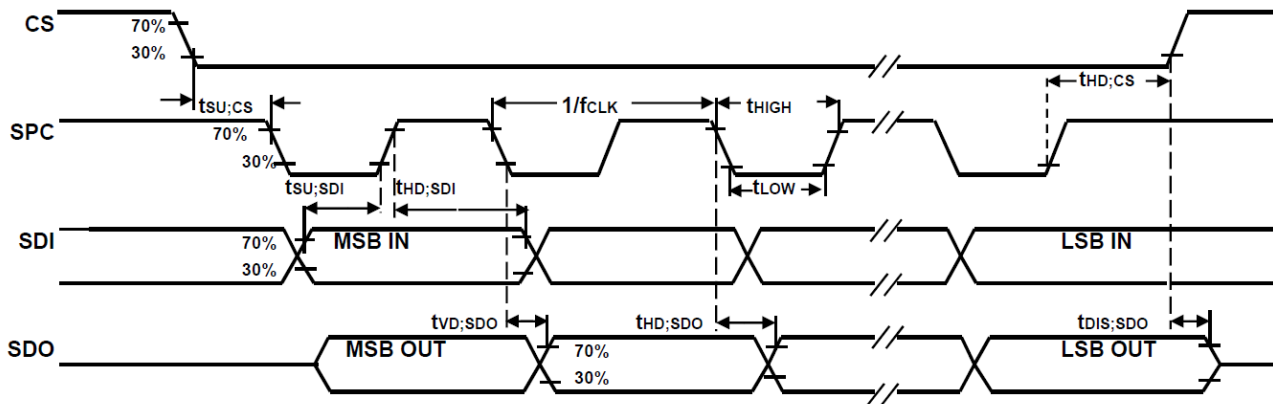


Figure 2: SPI Timing Diagram



## 5 Functional Description

The IDG-2030U is single-chip, digital output, 2 Axis MEMS gyroscope IC optimized for Optical Image Stabilization applications in mobile devices such as Smartphones, Tablets and Digital Still Cameras. It is designed to be resistant to ultrasonic wash frequencies ranging from 36 kHz to 40 KHz. It also features a 512-byte FIFO for applications such as Electronic Image Stabilization where the gyro output is sampled at a fast rate, e.g. 1 kHz, but is only needed at the video frame rate (ex: 30 fps). The FIFO can store the samples within a frame, lower the traffic on the serial bus interface, and reduce power consumption by allowing the system processor to burst read sensor data and then go into a low-power mode. The FSYNC (Frame Sync) input can alternatively be used by the host to generate an interrupt to allow precise timing to be achieved with Video Frame Sync at the host level for read out of the frame data.

The IDG-2030U consists of a single structure vibratory MEMS rate gyroscope, which detects rotation about the X&Y. When the gyro is rotated about any of the sense axes, the Coriolis Effect causes a vibration that is detected by a capacitive pick off CV. The resulting signal is amplified, demodulated, and filtered to produce a voltage that is proportional to the angular rate.

This voltage is digitized using individual on-chip 16-bit Analog-to-Digital Converters (ADCs) to sample each axis. The FSR range is optimized for image stabilization applications where the narrower range improves hand jitter detection accuracy via the 16 bit ADCs. User-selectable low-pass filters enable a wide range of cut-off frequencies. The ADC sample rate can be programmed to 32 kHz, 8 kHz, 1 kHz, 500 Hz, 333.3 Hz, 250 Hz, 200 Hz, 166.7 Hz, 142.9 Hz, or 125 Hz.

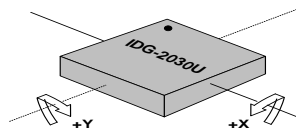


Figure 3: Orientation of Axes of Sensitivity and Polarity of Rotation

Figure 3 shows sensitivity axis orientation and rotation polarity. Note the pin 1 identifier for IDG-2030U.

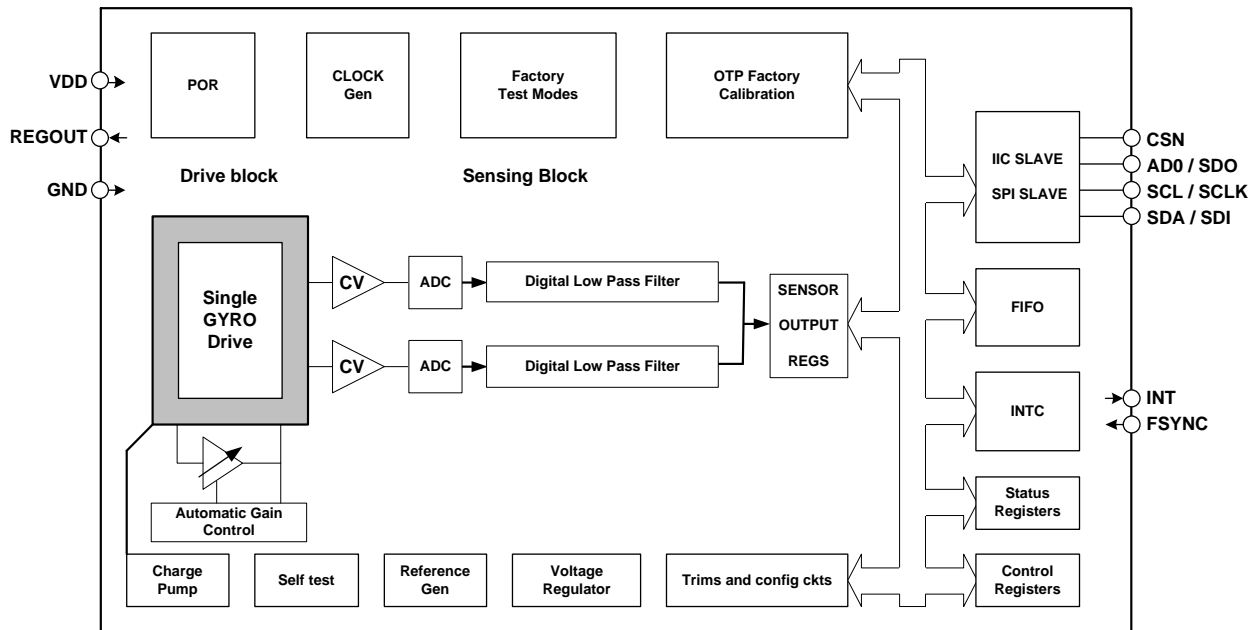


Figure 4: Block Diagram

Figure 4 identifies the key blocks. Two-axis MEMS rate gyroscope sensor with 16-bit ADCs and signal conditioning is available in two axis XY configuration. After the signal is digitized, data is processed through a digital low pass filter, sensor data registers and stored at a FIFO. The devices communicate via a register selectable I<sup>2</sup>C or SPI serial communications interface. Other blocks include on-board clocking, interrupts and bias circuits.

The IDG-2030U has both I<sup>2</sup>C and SPI serial interfaces. The device always acts as a slave when communicating to the system processor. The LSB of the of the I<sup>2</sup>C slave address is set by the AD0 pin.

The sensor data registers contain the latest gyro data. They are read-only registers, and are accessed via the Serial Interface. Data from these registers may be read anytime, however, the interrupt function may be used to determine when new data is available.

The IDG-2030U contains a 512-byte FIFO register that is accessible via both the I<sup>2</sup>C and SPI Serial Interfaces. The FIFO configuration register determines what data goes into it, with possible choices being gyro data and FSYNC input. A FIFO counter keeps track of how many bytes of valid data are contained in the FIFO. The FIFO register supports burst reads. The interrupt function may be used to determine when new data is available.

Interrupt functionality is configured via the Interrupt Configuration register. Items that are configurable include the INT pin configuration, the interrupt latching and clearing method, and triggers for the interrupt. Items that can trigger an interrupt are (1) Clock generator locked to new reference oscillator (used when switching clock sources), (2) new data is available to be read (from the FIFO and Data registers), and (3) FIFO overflow. The interrupt status can be read from the Interrupt Status register.

The bias and LDO section generates the internal supply and the reference voltages and currents required by the IDG-2030U with its input as unregulated VDD of 1.71V to 3.6V. The LDO output is bypassed by a 0.1µF capacitor at REGOUT.

## 6 I2C Serial Interface

### 6.1 I2C Interface Overview

The Inter Integrated Circuit (I<sup>2</sup>C) interface is a two-wire serial interface comprised of Serial Data (SDA, pin 5) and Serial Clock (SCL, pin 6). In general, the lines are open-drain and bi-directional. In a generalized I<sup>2</sup>C interface implementation, attached devices can be a master or a slave. The master device puts the slave address on the bus, and the slave device with the matching address acknowledges the master. For the IDG-2030U, pin 4 (AD0) defines the LSB of the I<sup>2</sup>C Slave Address.

The IDG-2030U always operates as a slave device when communicating to the system processor, which thus acts as the master. SDA and SCL lines typically need pull-up resistors to VDD. The maximum bus speed is 400 kHz.

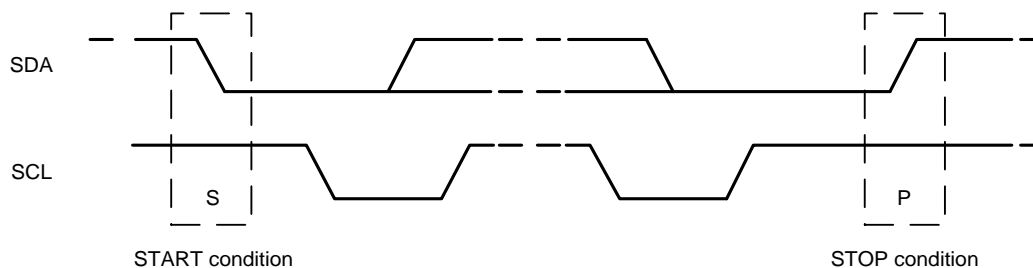
The slave address of the device is b110100X which is 7 bits long. The LSB bit of the 7 bit address is determined by the logic level on pin AD0. This allows up to two IDG-2030U devices to be connected to the same I<sup>2</sup>C bus. When used in this configuration, the address of the one of the devices should be b1101000 (pin AD0 is logic low) and the address of the other should be b1101001 (pin AD0 is logic high).

### 6.2 I2C Communications Protocol

#### START (S) and STOP (P) Conditions

Communication on the I<sup>2</sup>C bus starts when the master puts the START condition (S) on the bus, which is defined as a HIGH-to-LOW transition of the SDA line while SCL line is HIGH (see *Figure 5* below). The bus is considered to be busy until the master puts a STOP condition (P) on the bus, which is defined as a LOW to HIGH transition on the SDA line while SCL is HIGH.

Additionally, the bus remains busy if a repeated START (S) is generated instead of a STOP condition.

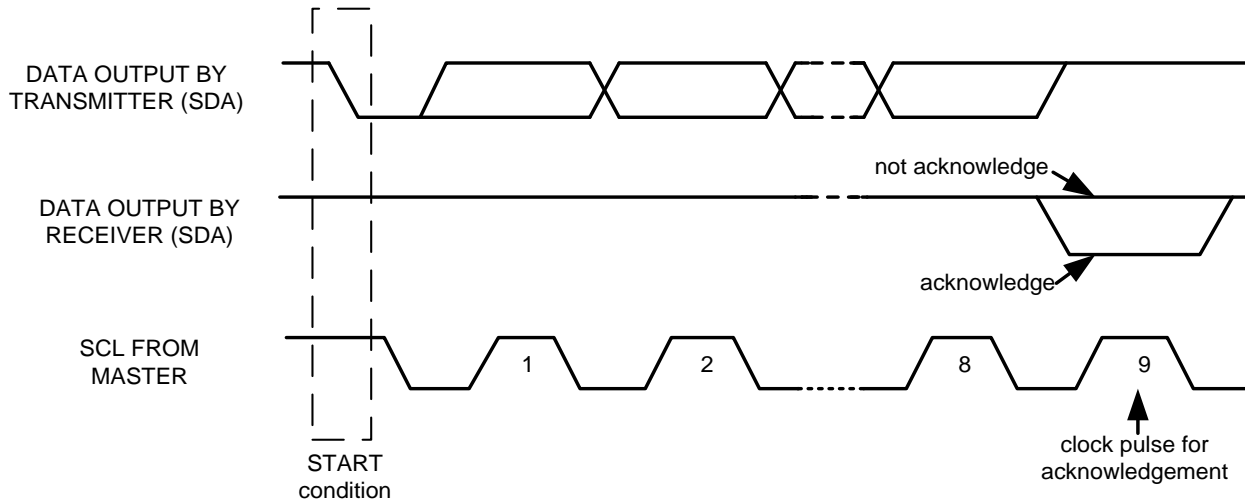


*Figure 5: I<sup>2</sup>C Start and Stop Conditions*

#### Data Format / Acknowledge

I<sup>2</sup>C data bytes are defined to be 8 bits long. There is no restriction to the number of bytes transmitted per data transfer. Each byte transferred must be followed by an acknowledge (ACK) signal. The clock for the acknowledge signal is generated by the master, while the receiver generates the actual acknowledge signal by pulling down SDA and holding it low during the HIGH portion of the acknowledge clock pulse.

If a slave is busy and is unable to transmit or receive another byte of data until some other task has been performed, it can hold SCL LOW, thus forcing the master into a wait state. Normal data transfer resumes when the slave is ready, and releases the clock line (refer to *Figure 6*).



*Figure 6: I<sup>2</sup>C Bus Acknowledge*

Table 1 summarizes available I<sup>2</sup>C signals and commands.

| Signal | Description  |
|--------|--|
| S      | Start Condition: SDA goes from high to low while SCL is high                               |
| AD     | Slave I <sup>2</sup> C address   |
| W      | Write bit (0)  |
| R      | Read bit (1)   |
| ACK    | Acknowledge: SDA line is low while the SCL line is high at the 9 <sup>th</sup> clock cycle |
| NACK   | Not-Acknowledge: SDA line stays high at the 9 <sup>th</sup> clock cycle                    |
| RA     | The internal register address  |
| DATA   | Transmit or received data  |
| P      | Stop condition: SDA going from low to high while SCL is high                               |

Table 1: I<sup>2</sup>C Signals and Commands

## Communications

After beginning communications with the START condition (S), the master sends a 7-bit slave address followed by an 8<sup>th</sup> bit, the read/write bit. The read/write bit indicates whether the master is receiving data from or is writing to the slave device. Then, the master releases the SDA line and waits for the acknowledge signal (ACK) from the slave device. Each byte transferred must be followed by an acknowledge bit. To acknowledge, the slave device pulls the SDA line LOW and keeps it LOW for the high period of the SCL line. Data transmission is always terminated by the master with a STOP condition (P), thus freeing the communications line. However, the master can generate a repeated START condition (S), and address another slave without first generating a STOP condition (P). A LOW to HIGH transition on the SDA line while SCL is HIGH defines the stop condition. All SDA changes should take place when SCL is low, with the exception of start and stop conditions.

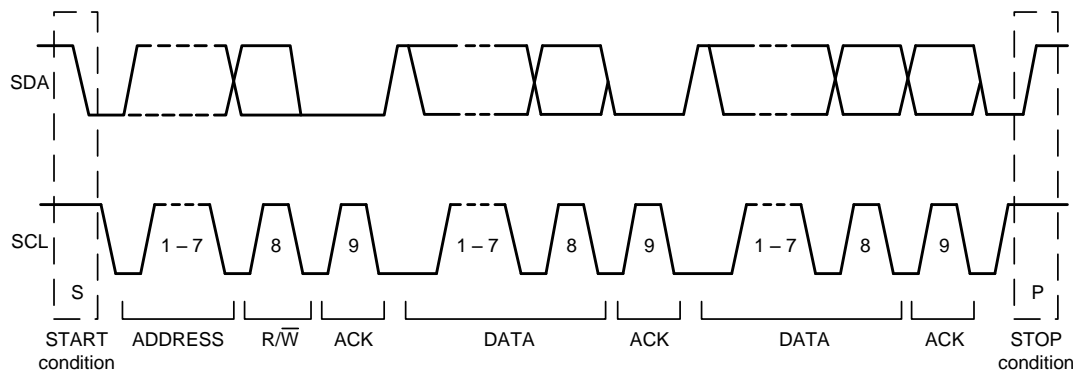


Figure 7: Complete I<sup>2</sup>C Data Transfer

To write the internal IDG-2030U registers, the master transmits the start condition (S), followed by the I<sup>2</sup>C address and the write bit (0). At the 9<sup>th</sup> clock cycle (when the clock is high), the device acknowledges the transfer. Then the master puts the register address (RA) on the bus. After the device acknowledges the reception of the register address, the master puts the register data onto the bus. This is followed by the ACK signal, and data transfer may be concluded by the stop condition (P). To write multiple bytes after the

last ACK signal, the master can continue outputting data rather than transmitting a stop signal. In this case, the device automatically increments the register address and loads the data to the appropriate register. Single and two-byte write sequences are shown below.

**Single-Byte Write Sequence**

|        |   |      |     |    |     |      |     |   |
|--------|---|------|-----|----|-----|------|-----|---|
| Master | S | AD+W |     | RA |     | DATA |     | P |
| Slave  |   |      | ACK |    | ACK |      | ACK |   |

**Burst Write Sequence**

|        |   |      |     |    |     |      |     |      |     |   |
|--------|---|------|-----|----|-----|------|-----|------|-----|---|
| Master | S | AD+W |     | RA |     | DATA |     | DATA |     | P |
| Slave  |   |      | ACK |    | ACK |      | ACK |      | ACK |   |

To read the internal device registers, the master sends a start condition, followed by the I<sup>2</sup>C address and a write bit, and then the register address that is going to be read. Upon receiving the ACK signal from the device, the master transmits a start signal followed by the slave address and read bit. As a result, the device sends an ACK signal and the data. The communication ends with a Not Acknowledge (NACK) signal and a stop bit from master. The NACK condition is defined such that the SDA line remains high at the 9<sup>th</sup> clock cycle. The following shows single and two-byte read sequences.

**Single-Byte Read Sequence**

|        |   |      |     |    |     |   |      |     |      |      |   |
|--------|---|------|-----|----|-----|---|------|-----|------|------|---|
| Master | S | AD+W |     | RA |     | S | AD+R |     |      | NACK | P |
| Slave  |   |      | ACK |    | ACK |   |      | ACK | DATA |      |   |

**Burst Read Sequence**

|        |   |      |     |    |     |   |      |     |      |     |      |      |   |
|--------|---|------|-----|----|-----|---|------|-----|------|-----|------|------|---|
| Master | S | AD+W |     | RA |     | S | AD+R |     |      | ACK |      | NACK | P |
| Slave  |   |      | ACK |    | ACK |   |      | ACK | DATA |     | DATA |      |   |

## 7 SPI Interface

### 7.1 SPI Interface Overview

The Serial Peripheral Interface Bus (SPI) is a 4-wire synchronous serial interface that uses two control and two data lines. The IDG-2030U always operates as a Slave device during standard Master-Slave SPI operation. With respect to the Master, the Serial Clock output (SCLK, pin 6), the Data Output (SDO, pin 4) and the Data Input (SDI, pin 5) are shared among the Slave devices. The Master generates an independent Chip Select ( $\overline{CS}$ , pin 2) for each Slave device;  $\overline{CS}$  goes low at the start of transmission and goes back high at the end. The Serial Data Output (SDO) line remains in a high-impedance (high-z) state when the device is not selected, so it does not interfere with any active devices.

### 7.2 SPI Operation

1. Data is delivered MSB first and LSB last
2. Data is latched on rising edge of SCLK
3. Data should be transitioned on the falling edge of SCLK
4. SCLK frequency is 1MHz max for SPI in full read/write capability mode.  
At 20MHz, its operation is limited to reading sensor registers only.
5. SPI read and write operations are completed in 16 or more clock cycles (two or more bytes).  
The first byte contains the SPI Address, and the following byte(s) contain(s) the SPI data. The first bit of the first byte contains the Read/Write bit and indicates the Read (1) or Write (0) operation.

The following 7 bits contain the Register Address. For multiple-byte Read/Writes, data is two or more bytes;

#### SPI Address format

|            |    |    |    |    |    |    |            |
|------------|----|----|----|----|----|----|------------|
| <b>MSB</b> |    |    |    |    |    |    | <b>LSB</b> |
| R/W        | A6 | A5 | A4 | A3 | A2 | A1 | A0         |

#### SPI Data format

|            |    |    |    |    |    |    |            |
|------------|----|----|----|----|----|----|------------|
| <b>MSB</b> |    |    |    |    |    |    | <b>LSB</b> |
| D7         | D6 | D5 | D4 | D3 | D2 | D1 | D0         |

6. SPI supports Single or Burst Read/Writes.

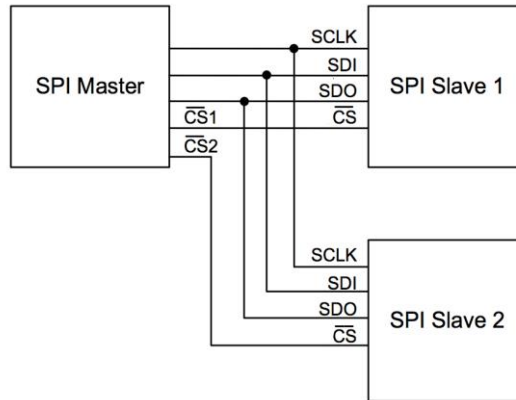


Figure 8: Typical SPI Master / Slave Configuration

As shown in *Figure 8*, each SPI slave requires its own Chip Select ( $\overline{CS}$ ) line. SDO, SDI and SCLK lines are shared. Only one  $\overline{CS}$  line is active (low) at a time ensuring that only one slave is selected at a time. The  $\overline{CS}$  lines of other slaves are held high which causes their respective SDO pins to be high-Z.



## 8 Register Maps and Description

### 8.1 Naming Conventions

Register Names are in CAPITAL LETTERS, while Register Values are in italicized *CAPITAL LETTERS*. For example, the GYRO\_XOUT\_H register (Register 67) contains the 8 most significant bits, *GYRO\_XOUT*[15:8], of the 16-bit X-Axis gyroscope measurement, *GYRO\_XOUT*.

The reset value is 0x00 for all registers except register 117, WHO\_AM\_I , which resets to 0x85.

| Addr (Hex) | Addr (Dec.) | Register Name | Serial I/F | Bit7             | Bit6          | Bit5              | Bit4           | Bit3            | Bit2              | Bit1            | Bit0           |
|------------|-------------|---------------|------------|------------------|---------------|-------------------|----------------|-----------------|-------------------|-----------------|----------------|
| 13         | 19          | XG_OFFS_USRH  | R/W        | X_OFFS_USR[15:8] |               |                   |                |                 |                   |                 |                |
| 14         | 20          | XG_OFFS_USRL  | R/W        | X_OFFS_USR[7:0]  |               |                   |                |                 |                   |                 |                |
| 15         | 21          | YG_OFFS_USRH  | R/W        | Y_OFFS_USR[15:8] |               |                   |                |                 |                   |                 |                |
| 16         | 22          | YG_OFFS_USRL  | R/W        | Y_OFFS_USR[7:0]  |               |                   |                |                 |                   |                 |                |
| 19         | 25          | SMPLRT_DIV    | R/W        | SMPLRT_DIV[7:0]  |               |                   |                |                 |                   |                 |                |
| 1A         | 26          | CONFIG        | R/W        | -                | FIFO_MODE     | EXT_SYNC_SET[2:0] |                |                 | DLPF_CFG[2:0]     |                 |                |
| 1B         | 27          | GYRO_CONFIG   | R/W        | XG_ST            | YG_ST         | -                 | FS_SEL [1:0]   |                 | -                 | FCHOICE_B[1:0]  |                |
| 23         | 35          | FIFO_EN       | R/W        | -                | XG_FIFO_EN    | YG_FIFO_EN        | -              | -               | -                 | -               | -              |
| 37         | 55          | INT_PIN_CFG   | R/W        | INT_LEVEL        | INT_OPEN      | LATCH_INT_EN      | INT_RD_CLEAR   | FSYNC_INT_LEVEL | FSYNC_INT_MODE_EN | -               | -              |
| 38         | 56          | INT_ENABLE    | R/W        | -                | -             | -                 | FIFO_OFLOW_EN  | FSYNC_INT_EN    | -                 | -               | DATA_RDY_EN    |
| 3A         | 58          | INT_STATUS    | R          | -                | -             | -                 | FIFO_OFLOW_INT | FSYNC_INT       | -                 | -               | DATA_RDY_INT   |
| 43         | 67          | GYRO_XOUT_H   | R          | GYRO_XOUT[15:8]  |               |                   |                |                 |                   |                 |                |
| 44         | 68          | GYRO_XOUT_L   | R          | GYRO_XOUT[7:0]   |               |                   |                |                 |                   |                 |                |
| 45         | 69          | GYRO_YOUT_H   | R          | GYRO_YOUT[15:8]  |               |                   |                |                 |                   |                 |                |
| 46         | 70          | GYRO_YOUT_L   | R          | GYRO_YOUT[7:0]   |               |                   |                |                 |                   |                 |                |
| 6A         | 106         | USER_CTRL     | R/W        | -                | FIFO_EN       | -                 | I2C_IF_DIS     | -               | FIFO_RESET        | -               | SIG_COND_RESET |
| 6B         | 107         | PWR_MGMT_1    | R/W        | DEVICE_RESET     | SLEEP         | -                 | -              | -               | CLKSEL[2:0]       |                 |                |
| 72         | 114         | FIFO_COUNTH   | R/W        | -                | -             | -                 | -              | -               | -                 | FIFO_COUNT[9:8] |                |
| 73         | 115         | FIFO_COUNTL   | R/W        | FIFO_COUNT[7:0]  |               |                   |                |                 |                   |                 |                |
| 74         | 116         | FIFO_R_W      | R/W        | FIFO_DATA[7:0]   |               |                   |                |                 |                   |                 |                |
| 75         | 117         | WHO_AM_I      | R          | -                | WHO_AM_I[6:1] |                   |                |                 |                   | -               |                |

*Table 2: IDG-2030U Register Map*

**Note:** Register names ending in \_H and \_L contain the high and low bytes of an internal register value.

## 8.2 Register Descriptions

This section describes the function and contents of each register for IDG-2030U gyroscope.

**Note:** The device will come up in full power mode upon power-up. (i.e. not sleep mode). It is possible to configure the device to come up in “sleep” mode upon customer request for mass production.

## 8.3 Registers 0x13 to 0x18 – Gyroscope Offset Adjustment Registers

XG\_OFFS\_USRH, XG\_OFFS\_USRL, YG\_OFFS\_USRH, and YG\_OFFS\_USRL

### Type: Read/Write

| Register (Hex) | Register (Decimal) | Bit7             | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
|----------------|--------------------|------------------|------|------|------|------|------|------|------|
| 13             | 19                 | X_OFFS_USR[15:8] |      |      |      |      |      |      |      |
| 14             | 20                 | X_OFFS_USR[7:0]  |      |      |      |      |      |      |      |
| 15             | 21                 | Y_OFFS_USR[15:8] |      |      |      |      |      |      |      |
| 16             | 22                 | Y_OFFS_USR[7:0]  |      |      |      |      |      |      |      |

These registers are used to remove DC bias from the sensor outputs. The values in these registers are subtracted from the gyroscope sensor values before going into the sensor registers (see registers 67 to 72).

### Parameters:

XG\_OFFS\_USR\_H/L: 16-bit offset of X gyroscope (2’s complement)

YG\_OFFS\_USR\_H/L: 16-bit offset of Y gyroscope (2’s complement)

#### 8.4 Register 0x19 – Sample Rate Divider

##### SMPRT\_DIV

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7            | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
|----------------|--------------------|-----------------|------|------|------|------|------|------|------|
| 19             | 25                 | SMPLRT_DIV[7:0] |      |      |      |      |      |      |      |

This register specifies the divider from the gyroscope output rate that can be used to generate a reduced Sample Rate. Please note that this register is only effective when  $FCHOICE\_B[1:0] = 2'b00$  (Register 27) and  $DLPF\_CFG = 1, 2, 3, 4, 5, \text{ or } 6$  (Register 26). When  $FCHOICE\_B[1:0] = 2'b00$  but  $DLPF\_CFG = 0 \text{ or } 7$ , the Sample Rate is fixed at 8kHz and the divider in this register does not apply. When  $FCHOICE\_B[1:0] = 2'b01, 2'b10, \text{ or } 2'b11$ , the Sample Rate is fixed at 32kHz and the divider in this register does not apply. The sensor register output and FIFO output are both based on the Sample Rate. When this register is effective under the  $FCHOICE\_B$  and  $DLPF\_CFG$  settings, the reduced Sample Rate is generated by the formula below:

Sample Rate = Gyroscope Output Rate / (1 + SMPLRT\_DIV)  
where Gyroscope Output Rate = 1kHz.

**Parameters:**

$SMPLRT\_DIV$  8-bit unsigned value. The Sample Rate is determined by dividing the gyroscope output rate by this value.

#### 8.5 Register 0x1A – Configuration

##### CONFIG

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7 | Bit6      | Bit5              | Bit4 | Bit3 | Bit2          | Bit1 | Bit0 |
|----------------|--------------------|------|-----------|-------------------|------|------|---------------|------|------|
| 1A             | 26                 | -    | FIFO_MODE | EXT_SYNC_SET[2:0] |      |      | DLPF_CFG[2:0] |      |      |

This register configures the FIFO's mode of operation, the external Frame Synchronization (FSYNC) pin sampling and the Digital Low Pass Filter (DLPF) setting. Please note that the DLPF can only be used when  $FCHOICE\_B[1:0] = 2'b00$  (Register 27). When  $FIFO\_MODE$  is set to 1 and the FIFO is full, additional writes will not be written to the FIFO. When this bit is equal to 0 and the FIFO is full, additional writes will be written to the FIFO, replacing the oldest data. In order to enable and disable writing to the FIFO, use the enable bits in Register 35. For further information regarding the FIFO's operation, please refer to Register 116. An external signal connected to the FSYNC pin can be sampled by configuring  $EXT\_SYNC\_SET$ . Signal changes to the FSYNC pin are latched so that short strobes may be captured. The latched FSYNC signal will be sampled at the Sampling Rate, as defined in register 25. After sampling, the latch will reset to the current FSYNC signal state. The sampled value will be reported in place of the least significant bit in a sensor data register determined by the value of  $EXT\_SYNC\_SET$  according to the following table.

| Chip      | EXT_SYNC_SET | FSYNC Bit Location |
|-----------|--------------|--------------------|
| IDG-2030U | 0            | Input disabled     |

|  |   |                |
|--|---|----------------|
|  | 2 | GYRO_XOUT_L[0] |
|  | 3 | GYRO_YOUT_L[0] |

Table 3: EXT\_SYNC\_SET

The DLPF is configured by *DLPF\_CFG*, when *FCHOICE\_B*[1:0] = 2b'00. The gyroscope is filtered according to the value of *DLPF\_CFG* and *FCHOICE\_B* as shown in Table 4 below.

| FCHOICE_B |     | DLPF_CFG | Gyroscope      |            |          |
|-----------|-----|----------|----------------|------------|----------|
| <1>       | <0> |          | Bandwidth (Hz) | Delay (ms) | Fs (kHz) |
| 0         | 0   | 0        | 250            | 0.97       | 8        |
| 0         | 0   | 1        | 184            | 2.9        | 1        |
| 0         | 0   | 2        | 92             | 3.9        | 1        |
| 0         | 0   | 3        | 41             | 5.9        | 1        |
| 0         | 0   | 4        | 20             | 9.9        | 1        |
| 0         | 0   | 5        | 10             | 17.85      | 1        |
| 0         | 0   | 6        | 5              | 33.48      | 1        |
| 0         | 0   | 7        | 3600           | 0.17       | 8        |
| x         | 1   | x        | 8800           | 0.064      | 32       |
| 1         | 0   | x        | 3600           | 0.11       | 32       |

Table 4: F\_CHOICE\_B Register (Gyroscope Delay)

Note: Bit 7 is reserved.

**Parameters:**

- FIFO\_MODE** When set to 1 and the FIFO is full, additional writes will not be written to the FIFO.  
When equal to 0 and the FIFO is full, additional writes will be written to the FIFO, replacing the oldest data.
- EXT\_SYNC\_SET** In order to disable writing to the FIFO, use the enable bits in Register 35.
- DLPF\_CFG** 3-bit unsigned value. Configures the FSYNC pin sampling.
- DLPF\_CFG** 3-bit unsigned value. Configures the DLPF setting.

**8.6 Register 0x1B – Gyroscope Configuration**

**GYRO\_CONFIG**

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7  | Bit6  | Bit5 | Bit4        | Bit3 | Bit2 | Bit1           | Bit0 |
|----------------|--------------------|-------|-------|------|-------------|------|------|----------------|------|
| 1B             | 27                 | XG_ST | YG_ST | -    | FS_SEL[1:0] |      | -    | FCHOICE_B[1:0] |      |

This register is used to trigger gyroscope self-test and configure the gyroscope' full scale range. Gyroscope self-test permits users to test the mechanical and electrical portions of the gyroscope. When self-test is activated by setting XG\_ST, YG\_ST bits in register 27, the on-board electronics will actuate the appropriate sensor. This actuation will move the sensor's proof masses over a distance equivalent to a pre-defined Coriolis force. This proof mass displacement results in a change in the sensor output, which is reflected in the output signal. The output signal is used to observe the self-test response. The self-test response (STR) is stored in the sensor data output registers 67 – 72. This self-test-response is used to determine whether the part has passed or failed self-test

*FS\_SEL* selects the full scale range of the gyroscope outputs according to the following Table 5.

| FS_SEL | Full Scale Range |
|--------|------------------|
| 0      | ± 46.5           |
| 1      | ± 93             |
| 2      | ± 187            |
| 3      | ± 374            |

Table 5: FS-SEL and Full Scale Range

*FCHOICE\_B*, in conjunction with *DLPF\_CFG* (Register 26), is used to choose the gyroscope output setting. For further information regarding the operation of *FCHOICE\_B*, please refer to Section 4.2. Note: Bit 2 is reserved.

**Parameters:**

- XG\_ST*                      Setting this bit causes the X axis gyroscope to perform self-test.
- YG\_ST*                      Setting this bit causes the Y axis gyroscope to perform self-test.
- FS\_SEL*                     2-bit unsigned value. Selects the full scale range of gyroscope.
- FCHOICE\_B*                2-bit unsigned value used to choose the gyroscope output setting.

**8.7 Register 0x23 – FIFO Enable**

**FIFO\_EN**

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7 | Bit6       | Bit5       | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
|----------------|--------------------|------|------------|------------|------|------|------|------|------|
| 23             | 35                 | -    | XG_FIFO_EN | YG_FIFO_EN | -    | -    | -    | -    | -    |

This register determines which sensor measurements are loaded into the FIFO buffer. Data stored inside the sensor data registers (Registers 65 to 72) will be loaded into the FIFO buffer if a sensor’s respective *FIFO\_EN* bit is set to 1 in this register. The behavior of FIFO writes when the FIFO buffer is full can be configured with the *FIFO\_MODE* bit (Register 26). In order to read the data in the FIFO buffer, the *FIFO\_EN* bit (Register 106) must be enabled. When a sensor’s *FIFO\_EN* bit is enabled in this register, data from the sensor data registers will be loaded into the FIFO buffer. The sensors are sampled at the Sample Rate as defined in Register 25. For further information regarding sensor data registers, please refer to Registers 65 to 72. Bits 7 and 3 through 0 are reserved.

**Parameters:**

- XG\_FIFO\_EN*                When set to 1, this bit enables *GYRO\_XOUT\_H* and *GYRO\_XOUT\_L* (Registers 67 and 68) to be written into the FIFO buffer.
- YG\_FIFO\_EN*                When set to 1, this bit enables *GYRO\_YOUT\_H* and *GYRO\_YOUT\_L* (Registers 69 and 70) to be written into the FIFO buffer.

**8.8 Register 0x37 – INT Pin / Bypass Enable Configuration**

**INT\_PIN\_CFG**

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7      | Bit6     | Bit5         | Bit4         | Bit3            | Bit2              | Bit1 | Bit0 |
|----------------|--------------------|-----------|----------|--------------|--------------|-----------------|-------------------|------|------|
| 37             | 55                 | INT_LEVEL | INT_OPEN | LATCH_INT_EN | INT_RD_CLEAR | FSYNC_INT_LEVEL | FSYNC_INT_MODE_EN | -    | -    |

This register configures the behavior of the interrupt signals at the INT pins. This register is also used to enable the FSYNC Pin to be used as an interrupt to the host application processor. Bits 1 and 0 are reserved.

**Parameters:**

- INT\_LEVEL** When this bit is equal to 0, the logic level for the INT pin is active high. When this bit is equal to 1, the logic level for the INT pin is active low.
- INT\_OPEN** When this bit is equal to 0, the INT pin is configured as push-pull. When this bit is equal to 1, the INT pin is configured as open drain.
- LATCH\_INT\_EN** When this bit is equal to 0, the INT pin emits a 50us long pulse. When this bit is equal to 1, the INT pin is held high until the interrupt is cleared.
- INT\_RD\_CLEAR** When this bit is equal to 0, interrupt status bits are cleared only by reading INT\_STATUS (Register 58) When this bit is equal to 1, interrupt status bits are cleared on any read operation.
- FSYNC\_INT\_LEVEL** When this bit is equal to 0, the logic level for the FSYNC pin (when used as an interrupt to the host processor) is active high. When this bit is equal to 1, the logic level for the FSYNC pin (when used as an interrupt to the host processor) is active low.
- FSYNC\_INT\_MODE\_EN** When this bit is equal to 1, the FSYNC pin will trigger an interrupt when it transitions to the level specified by *FSYNC\_INT\_LEVEL*. When a FSYNC interrupt is triggered, the *FSYNC\_INT* bit in Register 58 will be set to 1. An interrupt is sent to the host processor if the FSYNC interrupt is enabled by the *FSYNC\_INT\_EN* bit in Register 56. When this bit is equal to 0, the FSYNC pin is disabled from causing an interrupt.

**8.9 Register 0x38 – Interrupt Enable**

**INT\_ENABLE**

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7 | Bit6 | Bit5 | Bit4          | Bit3         | Bit2 | Bit1 | Bit0        |
|----------------|--------------------|------|------|------|---------------|--------------|------|------|-------------|
| 38             | 56                 | -    | -    | -    | FIFO_OFLOW_EN | FSYNC_INT_EN | -    | -    | DATA_RDY_EN |

This register enables interrupt generation by interrupt sources.

For information regarding the interrupt status for of each interrupt generation source, please refer to Register 58.

Bits 7 through 5, 2, and 1 are reserved.

**Parameters:**

- FIFO\_OFLOW\_EN** When set to 1, this bit enables a FIFO buffer overflow to generate an interrupt.
- FSYNC\_INT\_EN** When equal to 0, this bit disables the FSYNC pin from causing an interrupt to the host processor. When set to 1, this bit enables the FSYNC pin to be used as an interrupt to the host processor.

**DATA\_RDY\_EN** When set to 1, this bit enables the Data Ready interrupt. The Data Ready interrupt is triggered when all the sensor registers have been written with the latest gyro sensor data.

### 8.10 Register 0x3A – Interrupt Status

#### INT\_STATUS

**Type: Read Only**

| Register (Hex) | Register (Decimal) | Bit7 | Bit6 | Bit5 | Bit4              | Bit3      | Bit2 | Bit1 | Bit0         |
|----------------|--------------------|------|------|------|-------------------|-----------|------|------|--------------|
| 3A             | 58                 | -    | -    | -    | FIFO_OVERFLOW_INT | FSYNC_INT | -    | -    | DATA_RDY_INT |

This register shows the interrupt status of each interrupt generation source. Each bit will clear after the register is read.

For information regarding the corresponding interrupt enable bits, please refer to Register 56.

Bits 7 through 5, 2, and 1 are reserved.

**Parameters:**

**FIFO\_OVERFLOW\_INT** This bit automatically sets to 1 when a FIFO buffer overflow interrupt has been generated.

The bit clears to 0 after the register has been read.

**FSYNC\_INT** This bit automatically sets to 1 when an FSYNC interrupt has been generated.

The bit clears to 0 after the registers has been read.

**DATA\_RDY\_INT** This bit automatically sets to 1 when a Data Ready interrupt is generated.

The bit clears to 0 after the register has been read.

### 8.11 Registers 0x43 to 0x46 – Gyroscope Measurements

#### GYRO\_XOUT\_H, GYRO\_XOUT\_L, GYRO\_YOUT\_H, and GYRO\_YOUT\_L

**Type: Read Only**

| Register (Hex) | Register (Decimal) | Bit7            | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
|----------------|--------------------|-----------------|------|------|------|------|------|------|------|
| 43             | 67                 | GYRO_XOUT[15:8] |      |      |      |      |      |      |      |
| 44             | 68                 | GYRO_XOUT[7:0]  |      |      |      |      |      |      |      |
| 45             | 69                 | GYRO_YOUT[15:8] |      |      |      |      |      |      |      |
| 46             | 70                 | GYRO_YOUT[7:0]  |      |      |      |      |      |      |      |

These registers store the most recent gyroscope measurements. Gyroscope measurements are written to these registers at the Sample Rate as defined in Register 25.

The gyroscope sensor registers continuously update at the user selectable ODR sample rate whenever the serial interface is idle. It is recommended to use burst reads on host interface to guarantee a read of sensor registers will read measurements from the same sampling instant. Note that if burst reads are not used, the user is responsible for ensuring a set of single byte reads correspond to a single sampling instant by checking the Data Ready interrupt. Failing to do so, may result in reading the low and high byte of the same sensor from different samples which could appear as noise peaks to the user for example. The following should be considered for single byte read mode:

1. Data\_RDY\_INT gets generated any time the sensor registers get updated with the sensor data. The frequency of this interrupt is the same as the ODR which is user selectable. The INT Configurations, INT status register and INT pin can be configured using the user register 37h, 38h and 3Ah.

2. The sensor register outputs are 16 bits (2 bytes). Both bytes should be read at the same time in order to get reliable data using burst mode. If a single byte read is used, the host needs to read the bytes back to back after Data\_RDY\_INT is set to ensure both bytes are from same sample.
3. The sensor registers should be read at a faster rate than the selected ODR with the read cycle preferably completed for all the sensors to get consistent and reliable output.

Each 16-bit gyroscope measurement has a full scale defined in *FS\_SEL* (Register 27). For each full scale setting, the gyroscopes' sensitivity per LSB in *GYRO\_xOUT* is shown in *Table 6* below:

| FS_SEL | Full Scale Range |
|--------|------------------|
| 0      | ± 46.5           |
| 1      | ± 93             |
| 2      | ± 187            |
| 3      | ± 374            |

*Table 6: Gyro Full-Scale Sensitivity per LSB*

**Parameters:**

*GYRO\_XOUT* 16-bit 2's complement value.

Stores the most recent X axis gyroscope measurement.

*GYRO\_YOUT* 16-bit 2's complement value.

Stores the most recent Y axis gyroscope measurement.

**8.12 Register 0x6A – User Control**

**USER\_CTRL**

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7 | Bit6    | Bit5 | Bit4       | Bit3 | Bit2       | Bit1 | Bit0           |
|----------------|--------------------|------|---------|------|------------|------|------------|------|----------------|
| 6A             | 106                | -    | FIFO_EN | -    | I2C_IF_DIS | -    | FIFO_RESET | -    | SIG_COND_RESET |

This register allows the user to enable and disable the FIFO buffer and choose the primary I<sup>2</sup>C interface. The FIFO buffer, sensor signal paths and sensor registers can also be reset using this register.

The primary SPI interface will be enabled in place of the disabled primary I<sup>2</sup>C interface when *I2C\_IF\_DIS* is set to 1.

When the reset bits (*FIFO\_RESET* and *SIG\_COND\_RESET*) are set to 1, these reset bits will trigger a reset and then clear to 0.

Bits 7, 5, 3, and 1 are reserved.

**Parameters:**

*FIFO\_EN*

When set to 1, this bit enables FIFO operations.

When this bit is cleared to 0, the FIFO buffer is disabled. The FIFO buffer cannot be read from while disabled. However, it can still be written to. In order to disable writing to the FIFO, please use the enable bits in Register 35. The FIFO buffer's data will not be lost unless the FIFO is reset, or unless power cycled or soft reset.

*I2C\_IF\_DIS*

When set to 1, this bit disables the primary I<sup>2</sup>C interface and enables the SPI interface instead.

*FIFO\_RESET*

This bit resets the FIFO buffer when set to 1 while *FIFO\_EN* equals 0. This bit automatically clears to 0 after the reset has been triggered.



**SIG\_COND\_RESET** When set to 1, this bit resets the signal paths for all sensors. This operation will also clear the sensor registers. This bit automatically clears to 0 after the reset has been triggered.

### 8.13 Register 0x6B – Power Management 1

#### PWR\_MGMT\_1

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7         | Bit6  | Bit5 | Bit4 | Bit3 | Bit2        | Bit1 | Bit0 |
|----------------|--------------------|--------------|-------|------|------|------|-------------|------|------|
| 6B             | 107                | DEVICE_RESET | SLEEP | -    | -    | -    | CLKSEL[2:0] |      |      |

This register allows the user to configure the power mode and clock source. It also provides a bit for resetting the entire device.

By setting *SLEEP* to 1, the device can be put into low power sleep mode.

An internal 20MHz oscillator or the gyroscope based clock (PLL) can be selected as the device clock source. The PLL is the default clock source upon power up. In order for the gyroscope to perform to spec, the PLL must be selected as the clock source.

When the internal 20MHz oscillator is chosen as the clock source, the device can operate while having the gyroscope disabled. However, this is not a recommended normal operating mode.

The clock source can be selected according to *Table 7*.

| CLKSEL | Clock Source              |
|--------|---------------------------|
| 0      | Internal 20MHz oscillator |
| 1      | PLL                       |
| 2      | PLL                       |
| 3      | PLL                       |
| 4      | PLL                       |
| 5      | PLL                       |
| 6      | Internal 20MHz oscillator |
| 7      | Reserved                  |

*Table 7: Clock Source Select CLKSEL*

Bits 5 and 4 are reserved.

#### Parameters:

**DEVICE\_RESET** When set to 1, this bit resets all internal registers to their default values. The bit automatically clears to 0 once the reset is done.

The default values for each register can be found in Section 3.

**SLEEP** When set to 1, this bit puts the DEVICE into sleep mode.

**CLKSEL** 3-bit unsigned value. Specifies the clock source of the device.

### 8.14 Register 0x72 and 0x73 – FIFO Count Registers

#### FIFO\_COUNT\_H and FIFO\_COUNT\_L

**Type: Read Only**

| Register (Hex) | Register (Decimal) | Bit7            | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1            | Bit0 |
|----------------|--------------------|-----------------|------|------|------|------|------|-----------------|------|
| 72             | 114                | -               | -    | -    | -    | -    | -    | FIFO_COUNT[9:8] |      |
| 73             | 115                | FIFO_COUNT[7:0] |      |      |      |      |      |                 |      |

These registers keep track of the number of samples currently in the FIFO buffer in terms of the number of bytes stored.

These registers shadow the FIFO Count value. Both registers are loaded with the current sample count when FIFO\_COUNT\_H (Register 114) is read.

Note: Reading only FIFO\_COUNT\_L will not update the registers to the current FIFO COUNT value. FIFO\_COUNT\_H must be accessed first to update the contents of both these registers.

*FIFO\_COUNT* should always be read in high-low order in order to guarantee that the most current FIFO Count value is read.

Bits 7 through 2 of Register 114 are reserved.

**Parameters:**

*FIFO\_COUNT*

16-bit unsigned value. Indicates the number of bytes stored in the FIFO buffer. This number is in turn the number of bytes that can be read from the FIFO buffer and it is directly proportional to the number of samples available given the set of sensor data bound to be stored in the FIFO (register 35).

### 8.15 Register 0x74 – FIFO Read Write

#### FIFO\_R\_W

**Type: Read/Write**

| Register (Hex) | Register (Decimal) | Bit7           | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
|----------------|--------------------|----------------|------|------|------|------|------|------|------|
| 74             | 116                | FIFO_DATA[7:0] |      |      |      |      |      |      |      |

This register is used to read and write data from the FIFO buffer.

Data is written to the FIFO in order of register number (from lowest to highest). If all the FIFO enable flags (see below) are enabled, the contents of registers 65 through 72 will be written in order at the Sample Rate.

The contents of the sensor data registers (Registers 65 to 72) are written into the FIFO buffer when their corresponding FIFO enable flags are set to 1 in FIFO\_EN (Register 35).

If the FIFO buffer has overflowed, the status bit *FIFO\_OFLOW\_INT* is automatically set to 1. This bit is located in INT\_STATUS (Register 58). When the FIFO buffer has overflowed, the treatment of the new data is determined by the *FIFO\_MODE* bit in Register 26.

Check *FIFO\_COUNT* to ensure that the FIFO buffer is not read when empty.

**Parameters:**

*FIFO\_DATA*                    8-bit data transferred to and from the FIFO buffer.

### 8.16 Register 0x75 – Who Am I

#### WHO\_AM\_I

**Type: Read Only**

| Register (Hex) | Register (Decimal) | Bit7 | Bit6          | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 |
|----------------|--------------------|------|---------------|------|------|------|------|------|------|
| 75             | 117                | -    | WHO_AM_I[5:0] |      |      |      |      | -    | -    |

This register is used to verify the identity of the device. The default value of the register is 0x85. Bits 0 and 7 are reserved. (Hard coded to 1)

**Parameters:**

*WHO\_AM\_I*    The Power-On-Reset value of Bit6:Bit1 is 000 010.

## 9 Applications Information

### 9.1 Typical Operating Circuits

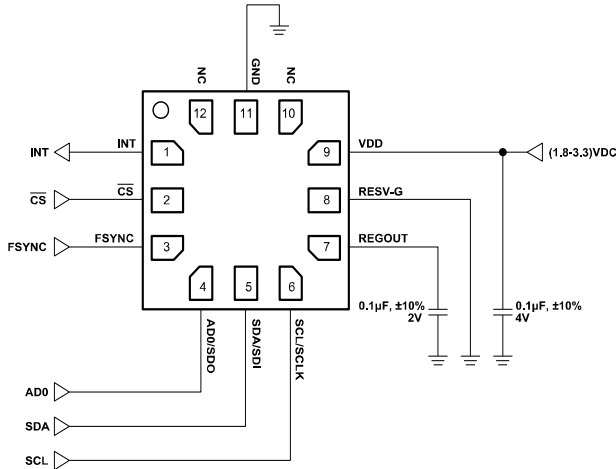


Figure 9: I<sup>2</sup>C Operation

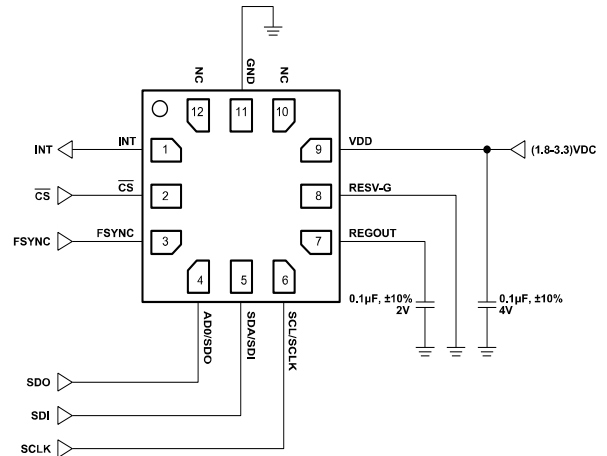


Figure 10: SPI Operation

### 9.2 System Bus Logic Levels

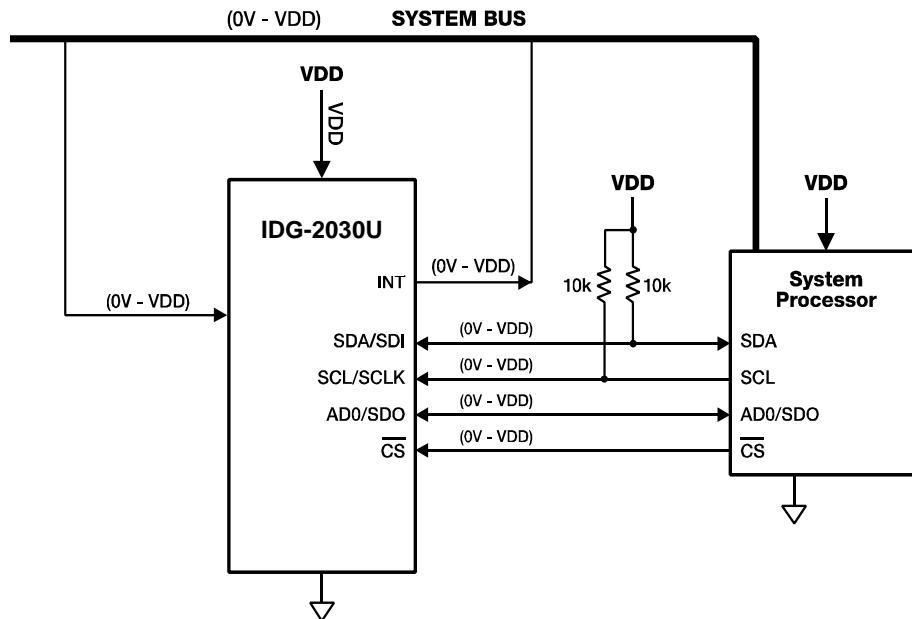


Figure 11: System Bus Logic Levels

As shown in Figure 11, the recommended logic levels for signal and data lines are 0V and VDD.

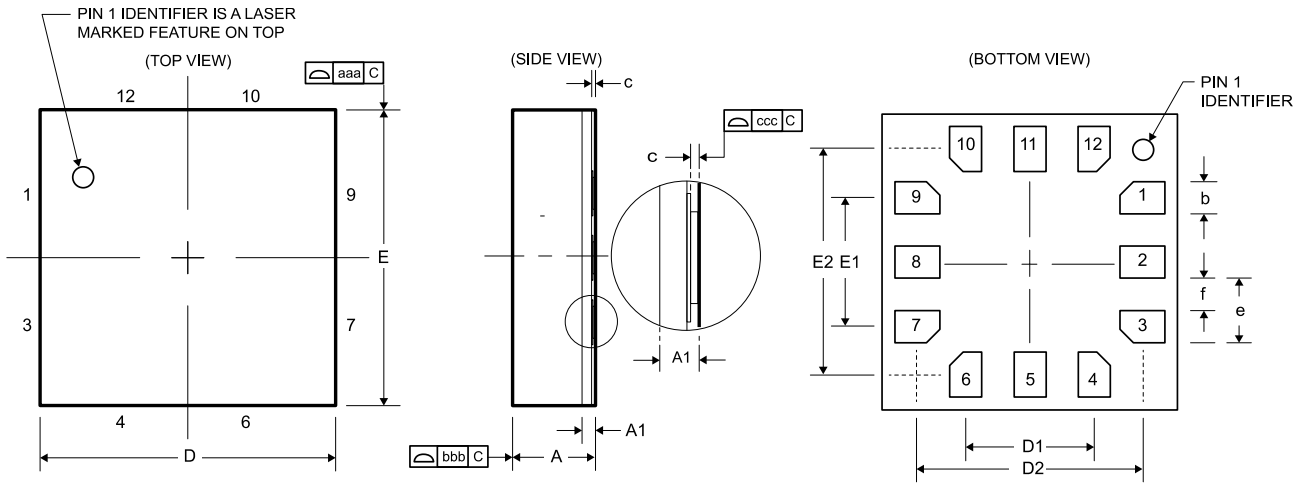
### 9.3 Adjustable Phase Delay

| Parameters   | FCHOICE_B |   | DLPF Configuration | Low pass Cutoff Fc | Frequency    | Resulting Phase Delay | Units      |
|--|-----------|---|--------------------|--------------------|--------------|-----------------------|------------|
| Phase Delay<br>SPI at 20MHz,<br>Typical Operating<br>Circuit, VDD = 2.5V,<br>T <sub>A</sub> =25°C. | 1         | 0 |                    |                    |              |                       |            |
|  | 0         | 1 | X                  | Bypass             | 20Hz         | 0.9                   | Deg        |
|  | 1         | 1 | 0                  | 250Hz              | 20Hz<br>10Hz | 7<br>3.5              | Deg<br>Deg |
|  | 1         | 1 | 1                  | 184Hz              | 20Hz<br>10Hz | 20<br>10              | Deg<br>Deg |
|  | 1         | 1 | 2                  | 92Hz               | 20Hz<br>10Hz | 28<br>14              | Deg<br>Deg |

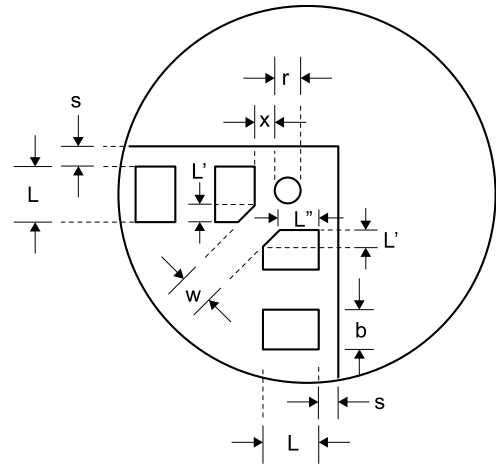
*Table 8: Adjustable Phase Delay with FCHOICE\_B Register and DLPF Settings*

The phase delay is configurable with registers FCHOICE\_B and DLPF as shown in *Table 8*.

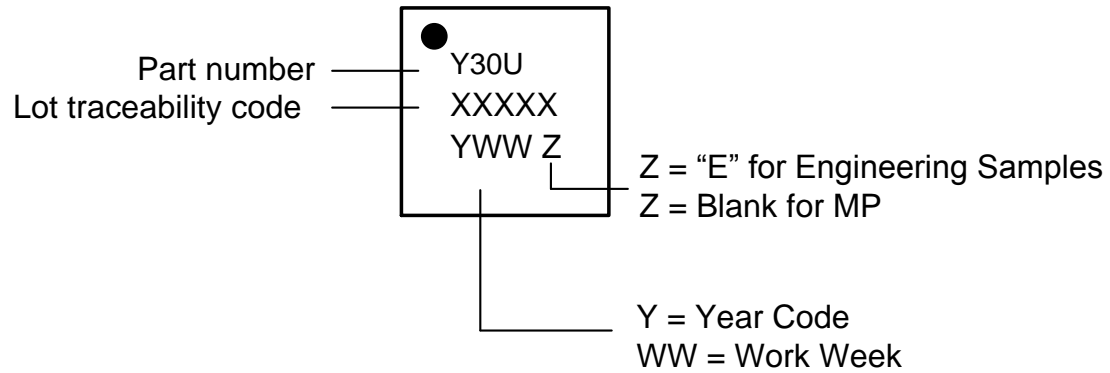
## 10 Package Information



| SYMBOLS        | DESCRIPTION                                | DIMENSIONS IN MILLIMETERS |           |      |
|----------------|--|---------------------------|-----------|------|
|                |  | MIN                       | NOM       | MAX  |
| <b>A</b>       | Package Thickness                          | 0.58                      | 0.645     | 0.70 |
| <b>A1</b>      | Substrate Thickness                        | ---                       | 0.105 REF | ---  |
| <b>b</b>       | Lead Width                                 | 0.2                       | 0.25      | 0.30 |
| <b>c</b>       | Seating Plane                              | ---                       | 0.08      | ---  |
| <b>D</b>       | Package Body Width                         | 2.25                      | 2.30      | 2.35 |
| <b>D1</b>      | Edge Lead Center to Center                 | ---                       | 1.00      | ---  |
| <b>D2</b>      | Center Lead Center to Center               | ---                       | 1.75      | ---  |
| <b>E</b>       | Package Body Length                        | 2.25                      | 2.30      | 2.35 |
| <b>E1</b>      | Edge Lead Center to Center (axial)         | ---                       | 1.00      | ---  |
| <b>E2</b>      | Edge Lead Center to Center (centerline)    | ---                       | 1.75      | ---  |
| <b>e</b>       | Lead Finger (Pad to Pad) Pitch             | ---                       | 0.50      | ---  |
| <b>f (e-b)</b> | Lead Finger (Pad to Pad) Space             | ---                       | 0.25      | ---  |
| <b>L</b>       | Lead Finger (Pad) Length                   | 0.30                      | 0.35      | 0.40 |
| <b>L'</b>      | Corner Lead Finger (Pad) Chamfer Length    | ---                       | 0.105     | ---  |
| <b>L''</b>     | Corner Lead Finger (Pad) Short Side Length | ---                       | 0.245     | ---  |
| <b>r</b>       | Align Feature Dimension                    | ---                       | 0.250     | ---  |
| <b>x</b>       | Space Align Feature to Lead                | ---                       | 0.20      | ---  |
| <b>s</b>       | Space Lead Finger to Package Edge          | ---                       | 0.10 REF  | ---  |
| <b>w</b>       | Width Between Corner Leads                 | 0.2                       | 0.25      | 0.3  |
| <b>aaa</b>     | Package Edge Tolerance                     | ---                       | 0.05 REF  | ---  |
| <b>bbb</b>     | Mold Flatness                              | ---                       | 0 REF     | ---  |
| <b>ccc</b>     | Coplanarity                                | ---                       | 0.08 REF  | ---  |



**TOP VIEW**



Part Number Identification:

| Product   | Top Mark         |                      |
|-----------|------------------|----------------------|
|           | Production Parts | Engineering Samples  |
| IDG-2030U | Y30U             | "E" on the last line |

## 11 Revision History

| Revision Date | Revision | Description     |
|---------------|----------|-----------------|
| 11/30/2016    | 1.0      | Initial release |



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Patent: [www.invensense.com/patents.html](http://www.invensense.com/patents.html)

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